HR315B 315MHz One-Port SAW Resonator For Wireless Remote Control



Approved by:

Checked by:

Issued by:

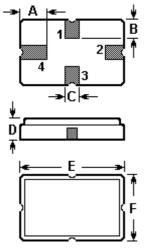
# **SPECIFICATION**

PRODUCT:SAW RESONATORMODEL:HR315BQCC4A

# HOPE MICROELECTRONICS CO., LIMITED

Tel:+86-755-82973806 Fax:+86-755-82973550 E-mail: <u>sales@hoperf.com</u> http://www.hoperf.com Page 1 of 1 The HR315B is a true one-port, surface-acoustic-wave (**SAW**) resonator in a surface-mount ceramic **QCC4A** case. It provides reliable, fundamental-mode, quartz frequency stabilization i.e. in transmitters or local oscillators operating at **315.000** MHz.

# 1.Package Dimension (QCC4A)



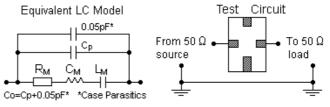
Pin	Configuration			
1	Input / Output			
3	Output / Input			
2/4	Case Ground			

Sign	Data (unit: mm)	Sign	Data (unit: mm)
А	1.2	D	1.4
В	0.8	E	5.0
С	0.5	F	3.5

# 2.Marking

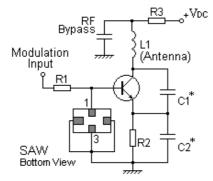
# **HR315B**

# 3.Equivalent LC Model and Test Circuit



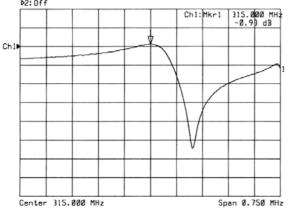
# **4.Typical Application Circuits**

1) Low-Power Transmitter Application

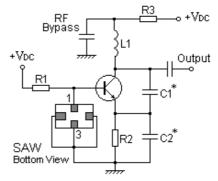


# **5.Typical Frequency Response**

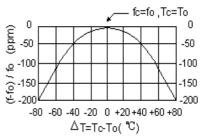
NI:Transmission /M Log Mag S.Ø dB/ Ref -1.50 dB Þ2:Dff



# 2) Local Oscillator Application



# **6.Temperature Characteristics**



The curve shown above accounts for resonator contribution only and does not include oscillator temperature characteristics.

# 7.Performance

#### 7-1.Maximum Ratings

Rating		Value	Unit	
CW RF Power Dissipation	Р	0	dBm	
DC Voltage Between Terminals	V <sub>DC</sub>	± 30	V	
Storage Temperature Range	$T_{\rm stg}$	-40 to +85		
Operating Temperature Range	T <sub>A</sub>	-10 to +60		

#### 7-2. Electronic Characteristics

	Characteristic	Sym	Minimum	Typical	Maximum	Unit
Center Frequency (+25)	Absolute Frequency	f <sub>C</sub>	314.925		315.075	MHz
	Tolerance from 315.000MHz	$\Delta f_{C}$		±75		kHz
Insertion Loss		IL		1.3	1.8	dB
Quality Factor	Unloaded Q	QU		11,950		
	50 $\Omega$ Loaded Q	QL		1,650		
Temperature Stability	Turnover Temperature	T <sub>0</sub>	25	39	55	
	Turnover Frequency	f <sub>0</sub>		f <sub>C</sub>		kHz
	Frequency Temperature Coefficient	FTC		0.032		ppm/ <sup>2</sup>
Frequency Aging Absolute Value during the First Year		f <sub>A</sub>		10		ppm/yr
DC Insulation Resis	tance Between Any Two Terminals		1.0			MΩ
RF Equivalent RLC Model	Motional Resistance	R <sub>M</sub>		16	23	Ω
	Motional Inductance	L <sub>M</sub>		96.7546		μH
	Motional Capacitance	См		2.6411		fF
	Shunt Static Capacitance	C <sub>0</sub>	2.60	2.85	3.10	pF

# **(i)**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling!

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- 1. The center frequency, f<sub>C</sub>, is measured at the minimum IL point with the resonator in the 50 test system.
- 2. Unless noted otherwise, case temperature  $T_C = +25^{\circ}C \pm 2^{\circ}C$ .
- Frequency aging is the change in f<sub>C</sub> with time and is specified at +65°C or less. Aging may exceed the specification for prolonged temperatures above +65°C. Typically, aging is greatest the first year after manufacture, decreasing in subsequent years.
- 4. Turnover temperature,  $T_0$ , is the temperature of maximum (or turnover) frequency,  $f_0$ . The nominal frequency at any case temperature,  $T_C$ , may be calculated from:  $f = f_0 [1 FTC (T_0 T_C)^2]$ .
- 5. This equivalent RLC model approximates resonator performance near the resonant frequency and is provided for reference only. The capacitance C<sub>0</sub> is the measured static (nonmotional) capacitance between the two terminals. The measurement includes case parasitic capacitance.
- 6. Derived mathematically from one or more of the following directly measured parameters:  $f_c$ , IL, 3 dB bandwidth,  $f_c$  versus  $T_c$ , and  $C_0$ .
- 7. The specifications of this device are based on the test circuit shown above and subject to change or obsolescence without notice.
- 8. Typically, equipment utilizing this device requires emissions testing and government approval, which is the responsibility of the equipment manufacturer.
- 9. Our liability is only assumed for the Surface Acoustic Wave (SAW) component(s) per se, not for applications, processes and circuits implemented within components or assemblies.
- 10. For questions on technology, prices and delivery, please contact our sales offices or e-mail sales@hoperf.com